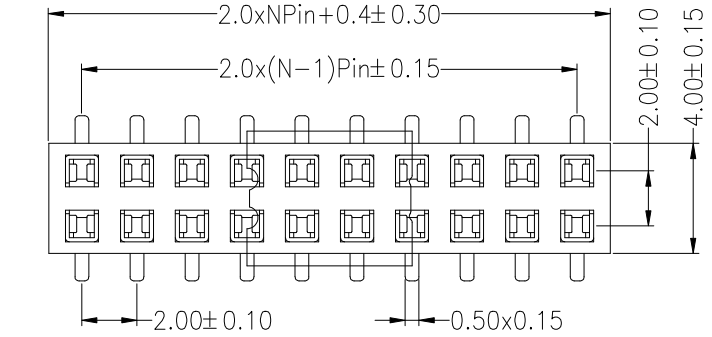
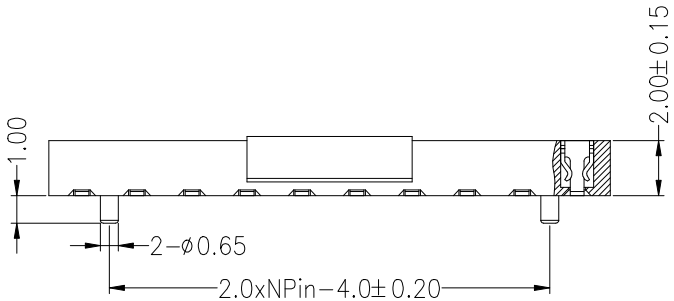
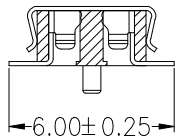
HSF RoHS FILE NO:E362810

SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

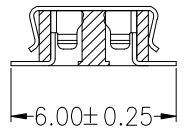
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Soldering temperature: 260°C±5° 5S







W= With Post

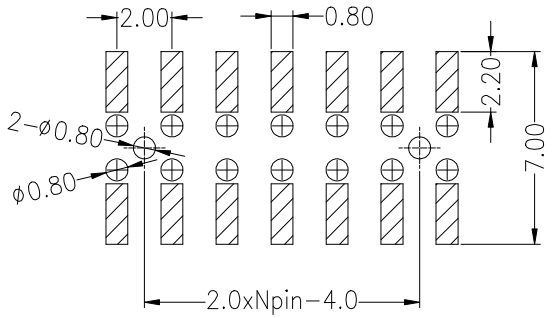


N= W/O Post

Ordering Information

2320T 2 XX X X XX M U X 0X

No.of Pins Per Row 2−40	Insulator Material Option C=BK−PA6T E=BK−PA9T F=BK−LCP	Post W=With Post N=W/O Post	Contact Plating G1::Gold Flash G2:1.5U" Gold G3:2U" Gold G4:3U" Gold G5:5U" Gold S0:Gold Flash/Tin SN:Tin	Packing A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar	



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.18	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.04.18
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	2320T2XXXXXXMUX0X
TITLE:	2.00PF H2.00mm 2xNpin SMT Bottom Entry